

38th Annual Semiconductor Thermal Measurement, Modeling and Management Symposium  
March 21-25, 2022 at the DoubleTree by Hilton, San Jose, CA USA

## About SEMI-THERM

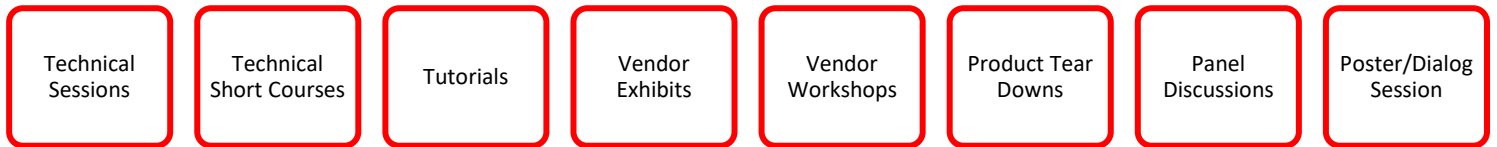
*SEMI-THERM is an international symposium dedicated to the thermal management and characterization of electronic components and systems. Its goals are to:*

- Provide knowledge covering all thermal length scales from integrated circuits to facility levels
- Foster discussions between thermal engineers, professionals and industry experts
- Encourage the exchange of information on academic and industrial advances in electronics cooling

**Topics Include:** Component/Board/System Thermal Design, Fluid Movers, Acoustics, Advanced Materials, Measurement Methods, Modeling & Simulation, Additive Manufacturing, Reliability, Design with AI, etc.

**Applications Include:** Processors/ICs/Memory, 3-D packaging, Computing Systems, Data Centers, Portable/Consumer/Wearable Electronics, Power Electronics, Harsh Environments, Defense/Aerospace Systems; Solid-State Lighting & Cooling, Biomedical; Micro/Nano-scale Devices, etc.

## Symposium Highlights



**Three options for participating in the technical program (additional details provided on [FAQs](#)):**

**Peer-reviewed paper:** Submit a full manuscript for peer review in October. Authors notified of acceptance in November. Reviewer comments provided to authors in December. Final manuscript due in January. Manuscripts will be provided to conference attendees and uploaded to IEEE Xplore.

**Non-peer-reviewed paper:** Submit an extended abstract (2-5 pages) that describes the scope, contents, key results, findings and conclusions. Authors notified of acceptance in November. Final manuscript due in January. Manuscripts will be provided to conference attendees and uploaded to IEEE Xplore.

**Presentation only:** Submit an extended abstract (2 -5 pages) that describes the scope, contents, key results, findings and conclusions. Authors notified of acceptance in November. Final presentation slides are due in March. Presentations will be provided to conference attendees.

**Awards:** All papers with manuscripts are eligible for the Best Paper Award. Student papers presented at the conference are eligible for Student Scholarships. Presentation-only submissions are not eligible for awards.

Manuscripts and extended abstracts submission deadline	Date that authors are notified of acceptance	Photo-ready full manuscript submission due date
Oct 18, 2021	Nov 15, 2021	Jan 17, 2022

Upload your paper electronically in RTF, DOC or PDF formats at [www.semi-therm.org](http://www.semi-therm.org).

For further information please contact the Program Chair

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Visit our website: <http://www.semi-therm.org>

**\*\* All authors qualify for reduced symposium rates \*\***